

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
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EYAL NEGREANU	12/10/2012
GIDEON AMIR	12/05/2012
MARK SANDLER	12/05/2012
YARON GRINWALD	12/10/2012
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State/Country:	NETHERLANDS
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14436829
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SIGNATURE:	/Steven L. Nichols/
DATE SIGNED:	04/20/2015
Total Attachments: 2	

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HEWLETT-PACKARD COMPANY
Intellectual Property Administrator
3404 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID: 83011212

ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each) have agreed and hereby agree, that for good and valuable consideration, the receipt of which is hereby acknowledged, and in furtherance of my/our obligations to HEWLETT-PACKARD INDIGO B.V., having its registered offices in Amstelveen, The Netherlands, (hereinafter HP-INDIGO), and to its subsidiaries and affiliates, in furtherance of my/our obligations to HP-INDIGO and its subsidiaries and affiliates, to assign and transfer to HP-INDIGO, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Patent entitled:

Method and Apparatus for Forming on a Substrate a Pattern
of a Material

Filing Date: _____ Application No.: _____

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Patent, and any and all other Patent of any countries thereto which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Patent.

I/we additionally authorize HP-INDIGO to file applications in my/our name for Patent in any country, to be held and enjoyed by HP-INDIGO, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Patent, to HP-INDIGO, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to HP-INDIGO, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid HP-INDIGO, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HP-INDIGO;

AND I/we hereby authorize and request the official of any country or countries whose duty it is to issue patents on applications as aforesaid, to issue to HP-INDIGO, as assignee of the entire right, title and interest, any and all Patent for said invention(s) or improvement(s) which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/we further authorize and direct the attorneys of record to insert the filing date and application number of said application for Patent, now identified by the Record ID and title set forth above, as soon as the same shall have been made known to them.

IN WITNESS WHEREOF, I/we hereunto set my/our hand(s) and seal(s):

Dror Kella _____ 5/12/12
Inventor's Signature Date Assignment Signed

Dror Kella _____ 5/12/12
Inventor's Typed Name Date Application Signed

Eyal Negreanu _____ 10/12/12
Inventor's Signature Date Assignment Signed

Eyal Negreanu _____ 10/12/12
Inventor's Typed Name Date Application Signed

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PATENT APPLICATION

RECORD ID: 83011212

ASSIGNMENT OF PATENT APPLICATION (cont.)

~12, 13/
Inventor's Signature _____ Date Assignment Signed 5-Dec-12

Gideon Amir
Inventor's Typed Name _____ Date Application Signed 5-Dec-12

[Signature]
Inventor's Signature _____ Date Assignment Signed 5 Dec 2012

Mark Sandler
Inventor's Typed Name _____ Date Application Signed 5 Dec 2012

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Inventor's Signature _____ Date Assignment Signed 10.12.12

Yaron Grinwald
Inventor's Typed Name _____ Date Application Signed 10.12.12

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Inventor's Typed Name _____ Date Application Signed

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